

Vishay Siliconix

COMPLIANT

N-Channel 150-V (D-S) MOSFET

PRODUCT	SUMMARY		
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)	Q _g (Тур)
150	0.018 at V _{GS} = 10 V	90 ^d	64

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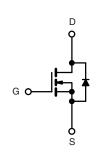
G D S Top View Ordering Information: SUP90N15-18P-E3 (Lead (Pb)-free)

FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- 100 % R_g and UIS Tested

APPLICATIONS

- Primary Side Switch
- Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _C = 25 °C, unless othe	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	150	V	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	I	90 ^d		
	T _C = 70 °C	D'D	75	A	
Pulsed Drain Current		I _{DM}	180	A	
Avalanche Current		I _{AS}	50		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	125	mJ	
	T _C = 25 °C	Р	375 ^b	w	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	P _D	3.75	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W
Junction-to-Case (Drain)	R _{thJC}	0.4	0/10

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

d. Package limited.

SUP90N15-18P

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V$, $I_{D} = 250 \mu A$	150			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.5		4.5	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 150 V, V_{GS} = 0 V, T_{J} = 125 °C			50	μA	
		$V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			Α	
Drain Source On State Registered ^a	r	V _{GS} = 10 V, I _D = 20 A		0.0145	0.018		
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.029	0.036	52	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		55		S	
Dynamic ^b							
Input Capacitance	C _{iss}			4180		Ω S pF nC	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 75 V, f = 1 MHz		235			pF
Reverse Transfer Capacitance	C _{rss}			83			
Total Gate Charge ^c	Qg			64	100		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 75 V, V_{GS} = 10 V, I_D = 85 A		23		nC	
Gate-Drain Charge ^c	Q _{gd}			16			
Gate Resistance	Rg	f = 1 MHz		2.1	4.2	Ω	
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	V_{DD} = 75 V, R_L = 0.88 Ω		10	15		
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 85 A, V_GEN = 10 V, R_g = 1 Ω		25	40	ns	
Fall Time ^c	t _f			8	15		
Source-Drain Diode Ratings and Cha	aracteristics 7	_C = 25 °C ^b					
Continuous Current	ا _S				90		
Pulsed Current	I _{SM}				180	A	
Forward Voltage ^a	V _{SD}	$I_F = 30 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			130	200	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/μs		8	12	А	
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC	

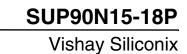
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

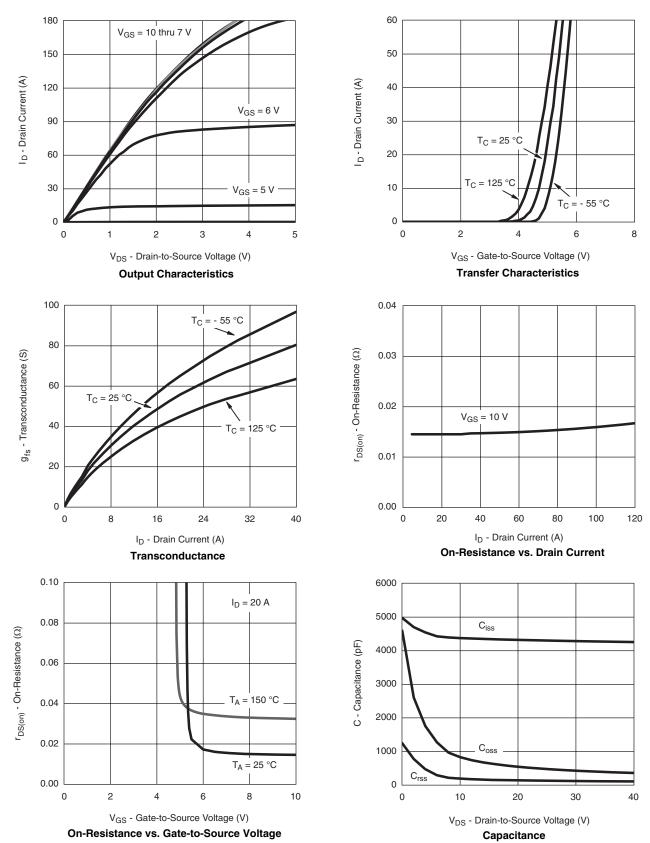
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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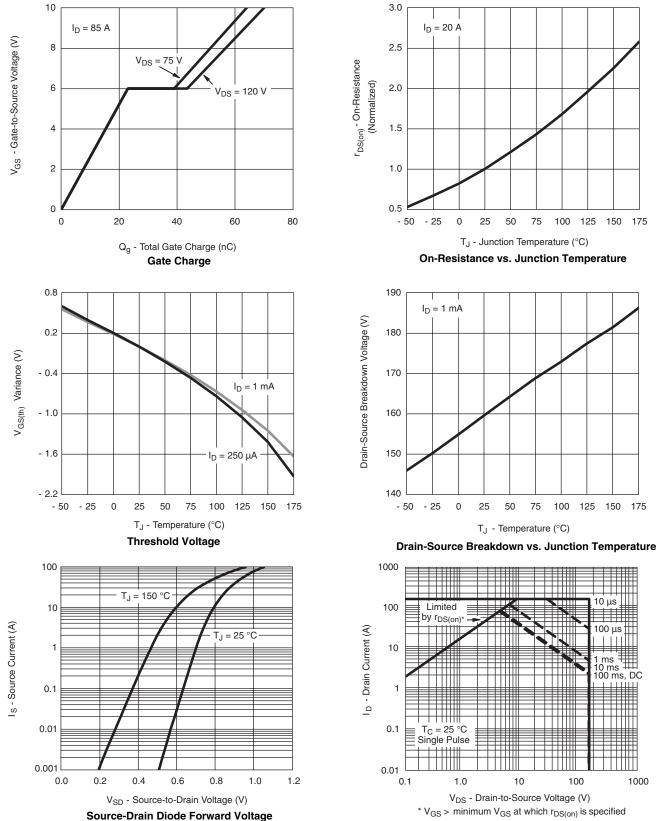


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SUP90N15-18P

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* V_{GS} > minimum V_{GS} at which r_{DS(on)} is specified Safe Operating Area, Junction-to-Case



150 175

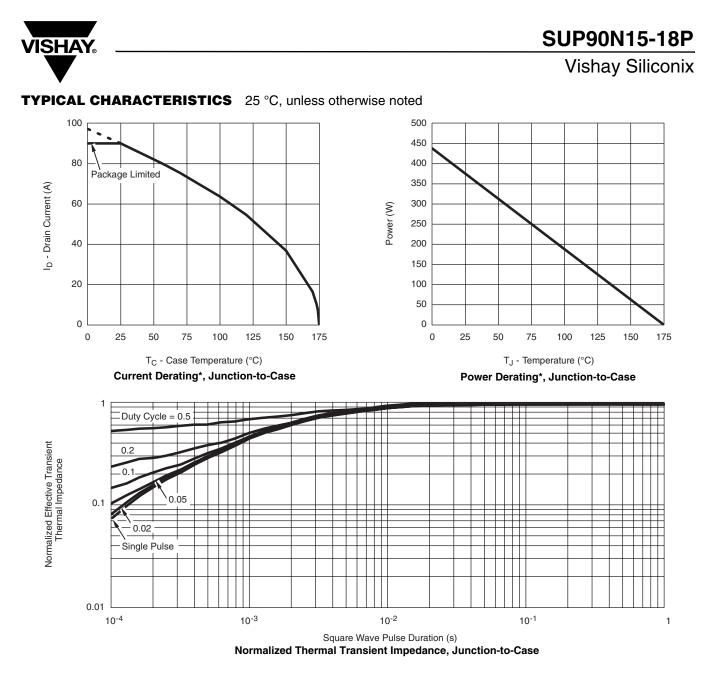
125 150 175

10 µs

100 us

ms ms 100 ms DC

1000



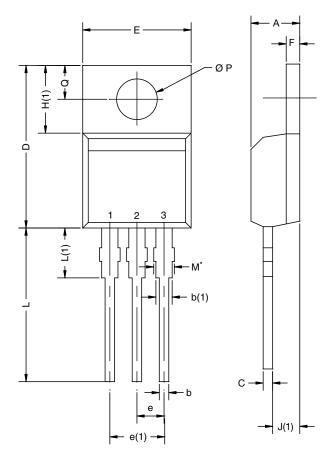
* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?69935.



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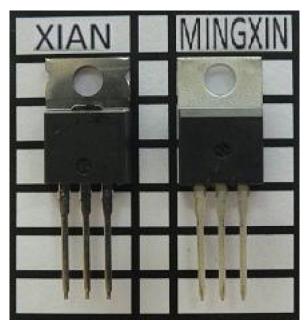


DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØΡ	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118

Notes

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

Xi'an and Mingxin actual photo



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